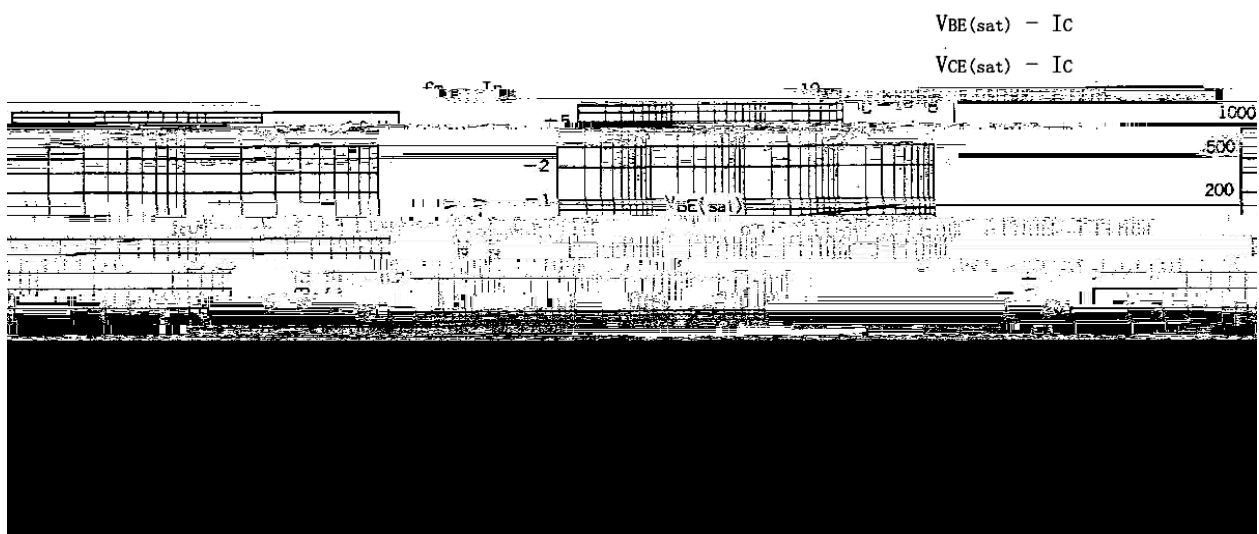
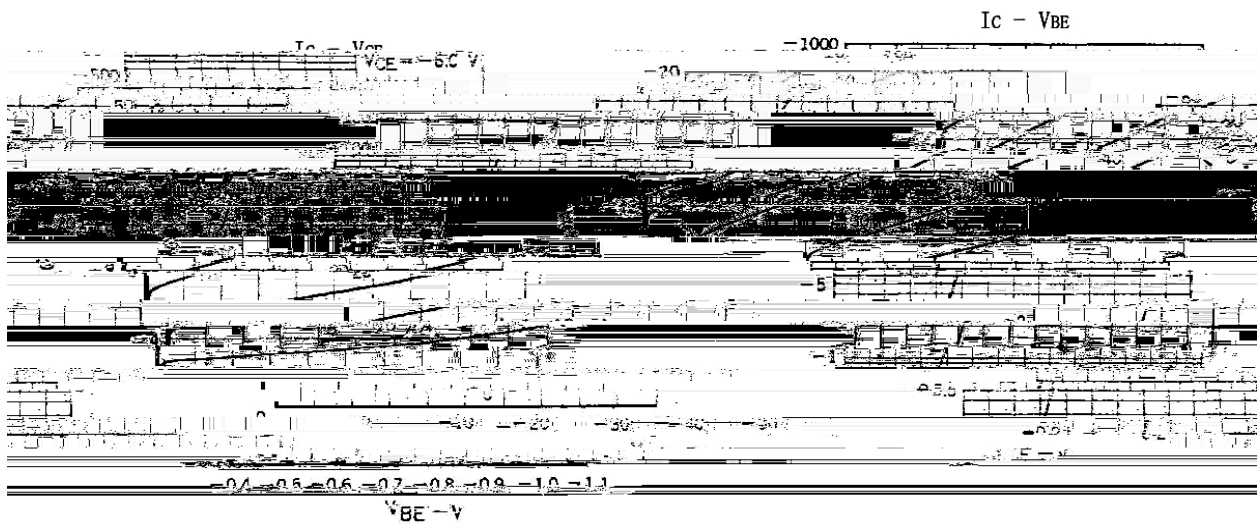
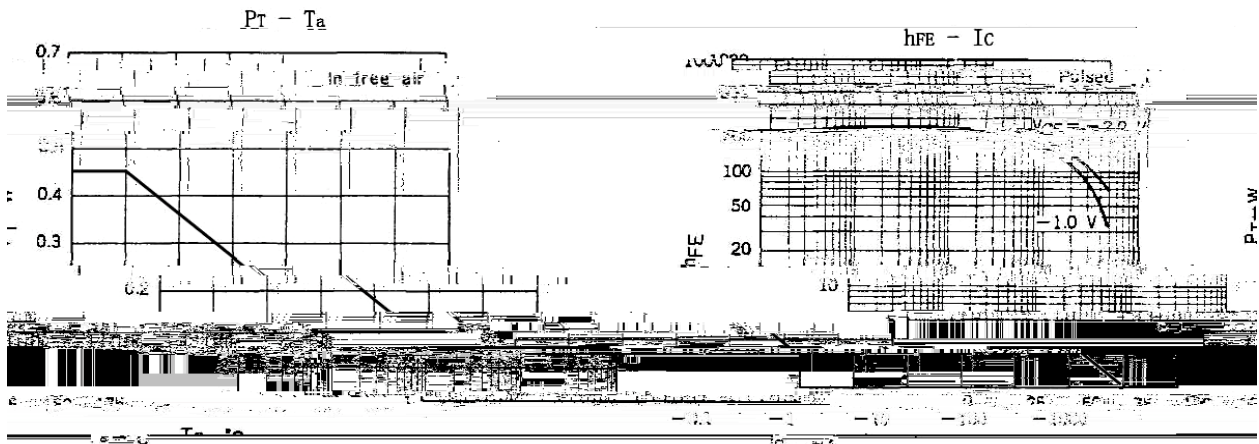
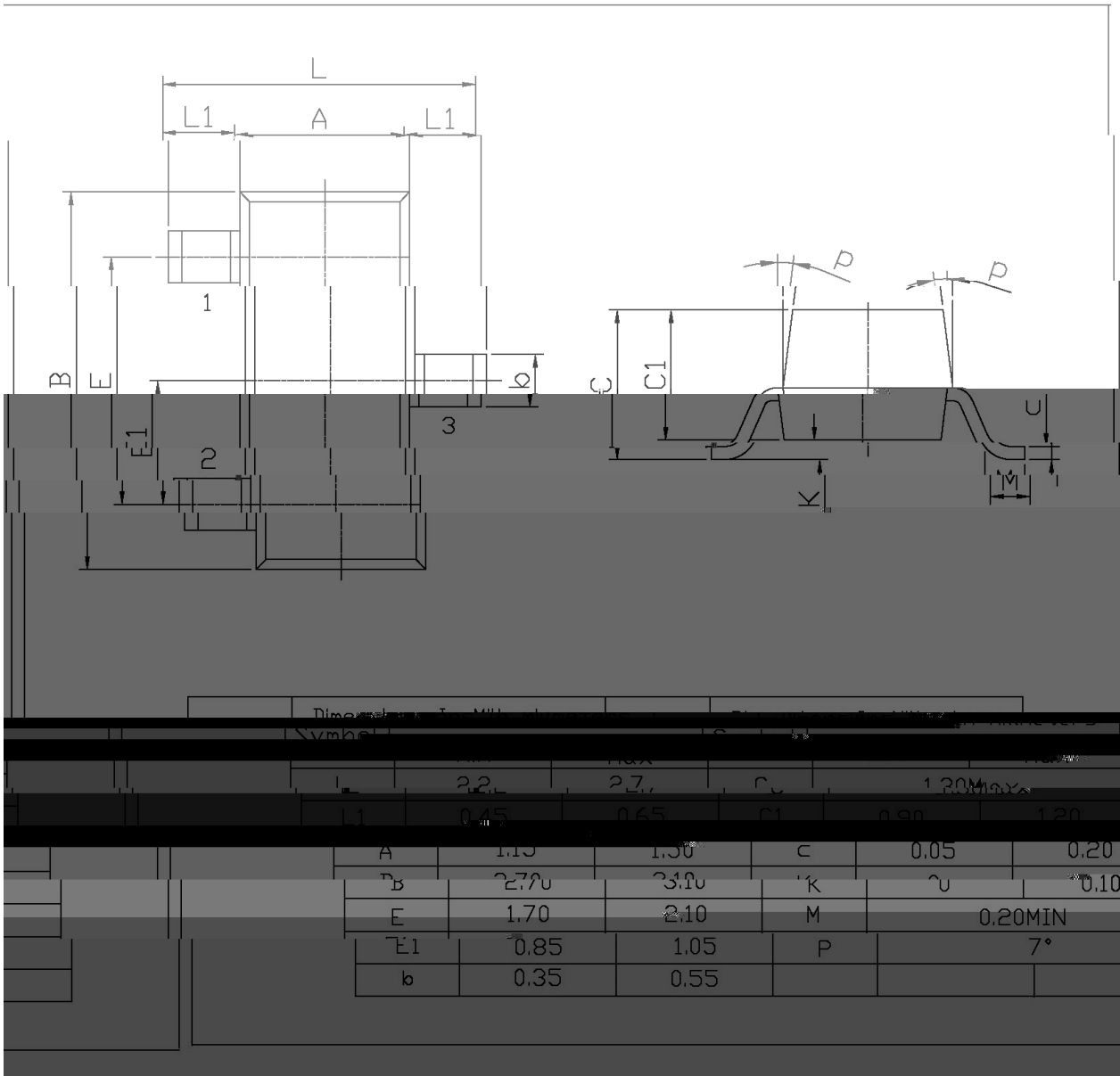
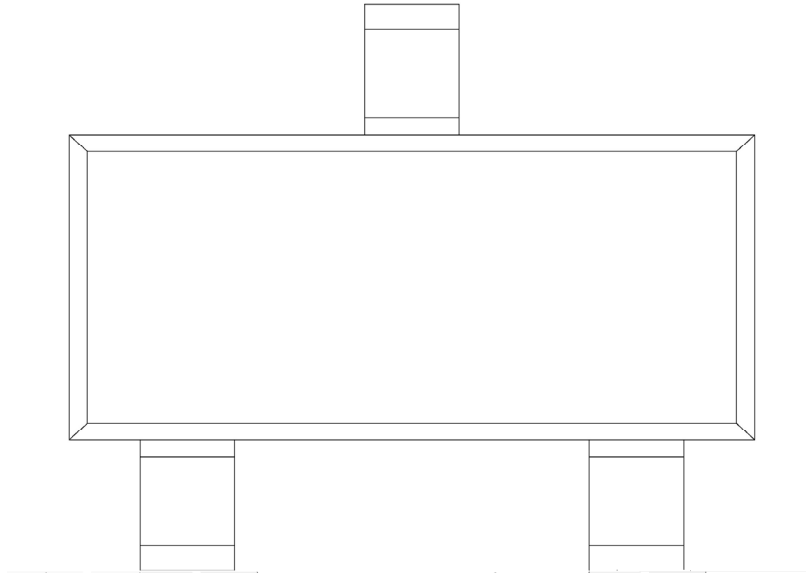




SMT-23

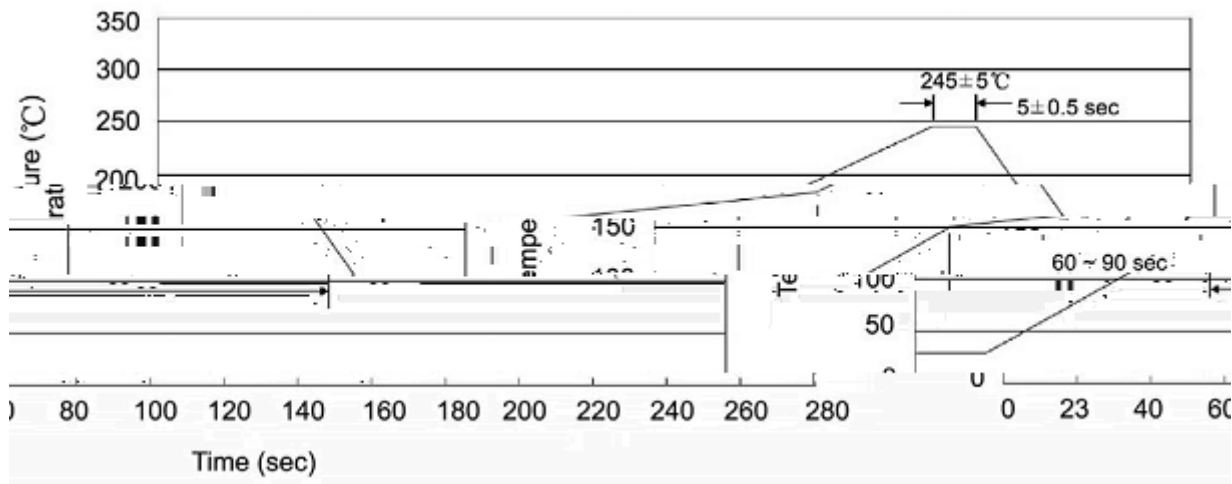
单位: mm





H
53
M

Temperature Profile for IR Reflow Soldering(Pb-Free)



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±

±

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±

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封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱